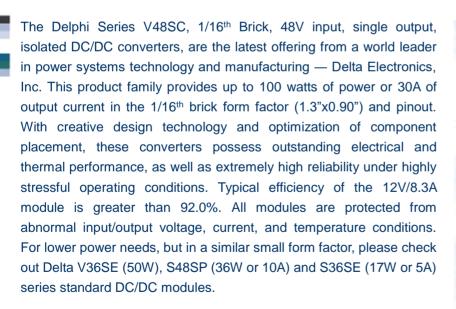


WDELPHI SERIES



Photo is for reference only

Delphi Series V48SC, 1/16th Brick 100W DC/DC Power Modules: 48V in, 12V, 8.3A out



FEATURES

- High efficiency: 92.0% @ 12V/8.3A
- Size:
- Without heat spreader: 33.0x22.8x8.8mm (1.30"x0.90"x0.35") With heat spreader 33.0x22.8x12.0mm (1.30"x0.90"x0.47")
- Industry standard footprint and pinout
- Fixed frequency operation
- SMD or through-hole versions
- Input UVLO
- OTP and output OCP. OVP
- Output voltage trim: -20%, +10%
- Monotonic startup into normal and pre-biased loads
- 1500V isolation and basic insulation
- No minimum load required
- No negative current during power or enable on/off
- ISO 9001, TL 9000, ISO 14001, QS 9000, OHSAS18001 certified manufacturing facility
- IEC/EN/UL/CSA 62368-1, 2nd edition
- IEC/EN/UL/CSA 60950-1, 2nd edition+A2

OPTIONS

- Short pin lengths available
- Positive remote On/Off
- Open frame with heat-spreader

SOLDERING METHOD

- Hand soldering
- Wave soldering
- Reflow soldering (MSL of rating 3)

APPLICATIONS

- Optical Transport
- Data Networking
- Communications
- Servers

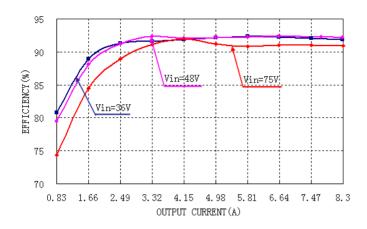


TECHNICAL SPECIFICATIONS

(T_A=25°C, airflow rate=300 LFM, V_{in}=48Vdc, nominal Vout unless otherwise noted.)

PARAMETER	NOTES and CONDITIONS	V48SC12008 (Standard)				
ABSOLUTE MAXIMUM RATINGS		Min.	Тур.	Max.	. ,	
Input Voltage						
Continuous				80	Vdc	
Transient (100ms)	100ms	40		100	Vdc	
Operating Ambient Temperature Storage Temperature		-40 -55		85 125	°C	
Input/Output Isolation Voltage		00		1500	Vdc	
INPUT CHARACTERISTICS						
Operating Input Voltage		36	48	75	Vdc	
Input Under-Voltage Lockout Turn-On Voltage Threshold		32.5	34.5	35.5	Vdc	
Turn-Off Voltage Threshold		29.5	31.5	33.5	Vdc	
Lockout Hysteresis Voltage		1.5	3	4	Vdc	
Maximum Input Current	100% Load, 36Vin			3.1	A	
No-Load Input Current Off Converter Input Current			60 8	12	mA mA	
Inrush Current (I ² t)	With 100uF external input capacitor		8	1	A ² s	
· · ·						
Input Reflected-Ripple Current Input Voltage Ripple Rejection	P-P thru 12µH inductor, 5Hz to 20MHz 120 Hz		-60	20	mA dB	
OUTPUT CHARACTERISTICS	120112		00		QD.	
Output Voltage Set Point	Vin=48V, Io=Io.max, Tc=25°C	11.82	12	12.18	Vdc	
Output Voltage Regulation	lo le minte le le			.40		
Over Load Over Line	lo=lo, min to Io, max Vin=36V to 75V		±5 ±5	±12 ±12	mV mV	
Over Temperature	Tc=-40°C to125°C		±5 ±180	TIZ	mV	
Total Output Voltage Range	Over sample load, line and temperature	11.64		12.36	V	
Output Voltage Ripple and Noise	5Hz to 20MHz bandwidth					
Peak-to-Peak	max load on output, 20MHz bandwidth		100		mV	
	10uF tantalum + 1uF ceramic capacitor max load on output, 20MHz bandwidth					
RMS	10uF tantalum + 1uF ceramic capacitor		30		mV	
Operating Output Current Range		0		8.3	Α	
Output Over Current Protection	Output Voltage 10% Low	110		140	%	
DYNAMIC CHARACTERISTICS	load capacitor10uF tantalum + 1u ceramic 0.1A/uS					
Output Voltage Current Transient	Frequency= 250Hz					
Positive Step Change in Output Current	50% lo.max to 75% lo.max		300		mV	
Negative Step Change in Output Current	75% lo.max to 50% lo.max		300		mV	
Settling Time (within 1% Vout nominal) Turn-On Transient			200		us	
Start-Up Delay Time, From On/Off Control or Input	From On/Off Control or Input to 10%Vo			15	ms	
Start-Up Rise Time, From On/Off Control or Input	From 10%Vo to 90% Vo			40	ms	
Maximum Output Capacitance	Full load; 5% overshoot of Vout at startup;	0		3300	μF	
EFFICIENCY 100% Load	Vin=48V		92.0		%	
60% Load	Viii=48V Vin=48V		92.0		%	
ISOLATION CHARACTERISTICS	VIII— TOV		02.0		70	
Input to Output				1500	Vdc	
Isolation Resistance		10	4000		MΩ	
Isolation Capacitance FEATURE CHARACTERISTICS			1000		pF	
Switching Frequency			420		kHz	
ON/OFF Control, Negative Remote On/Off logic						
Logic Low (Module On)	Von/off	0		0.7	V	
Logic High (Module Off) ON/OFF Control, Positive Remote On/Off logic	Von/off	2.4		5	V	
Logic Low (Module Off)	Von/off	0		0.7	V	
Logic High (Module On)	Von/off	2.4		5	V	
ON/OFF Current (for both remote on/off logic)	Ion/off at Von/off=0.0V			1	mA	
ON/OFF Current (for both remote on/off logic)	Ion/off at Von/off=2.4V				uA	
Leakage Current (for both remote on/off logic)	Logic High, Von/off=5V	-0.5		- 10	uA	
Output Voltage Trim Range	Max rated current guaranteed at full trim range Max rated current guaranteed at full remote sense	-20		10	%	
Output Voltage Remote Sense Range	range			10	%	
Output Over-Voltage Protection	Over full temp range; % of nominal Vout	110		140	%	
GENERAL SPECIFICATIONS	B. T.I. II CD and and I was a series					
MTBF	Per Telecordia SR-332, 80% load, 25°C, 48Vin,		4.9		M hours	
Weight	300LFM		15		gromo	
Weight	Open frame		15		grams	
weight	With heat-spreader Refer to Figure 22 for Hot spot1 location		24		grams	
			400		°C	
Over-Temperature Shutdown (Open Frame)			132			
1	(48Vin,80%lo, 200LFM,Airflow from Vout+ to Vin+) Refer to Figure 24 for Hot spot2 location					
Over-Temperature Shutdown (Open Frame) Over-Temperature Shutdown (With Heat Spreader) Over-Temperature Shutdown (NTC Resistor)	(48Vin,80%lo, 200LFM,Airflow from Vout+ to Vin+)		132 120 125		°C	

ELECTRICAL CHARACTERISTICS CURVES



12 POWER DISSIPATION(W) 8 Vin=75V 2 Vin=36V Vin 48V 0 2.49 4.15 4.98 5.81 7.47 8.3 0.83 1.66 6.64 OUTPUT CURRENT (A)

Figure 1: Efficiency vs. load current for minimum, nominal, and maximum input voltage at 25°C

Figure 2: Power dissipation vs. load current for minimum, nominal, and maximum input voltage at 25°C.

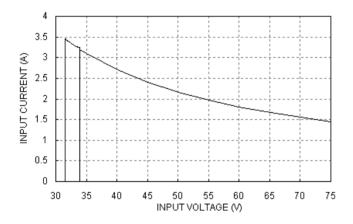


Figure 3: Typical full load input characteristics at room temperature

ELECTRICAL CHARACTERISTICS CURVES

For Negative Remote On/Off Start up

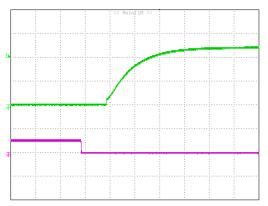


Figure 4: Turn-on transient at full rated load current (10 ms/div). Vin=48V. Top Trace: Vout, 5.0V/div; Bottom Trace: ON/OFF input, 5V/div

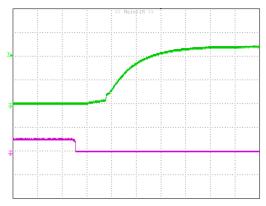


Figure 5: Turn-on transient at zero load current (10 ms/div). Vin=48V. Top Trace: Vout: 5.0V/div, Bottom Trace: ON/OFF input, 5V/div

For Input Voltage Start up

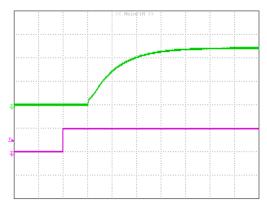


Figure 6: Turn-on transient at full rated load current (10 ms/div). Vin=48V. Top Trace: Vout, 5.0V/div; Bottom Trace: Vin, 50V/div

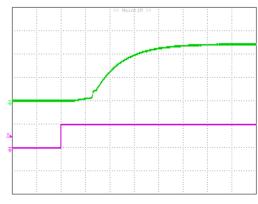


Figure 7: Turn-on transient at zero load current (10 ms/div). Vin=48V. Top Trace: Vout, 5.0V/div; Bottom Trace: Vin, 50V/div

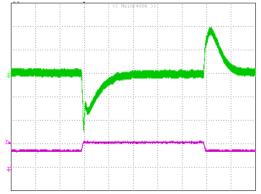


Figure 8: Output voltage response to step-change in load current (75%-50%-75% of lo, max; di/dt = 0.1A/ μ s). Load cap: 10 μ F tantalum capacitor and 1 μ F ceramic capacitor. Top Trace: Vout (0.15V/div, 200 μ s/div), Bottom Trace: lout (5A/div). Scope measurement should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module

ELECTRICAL CHARACTERISTICS CURVES

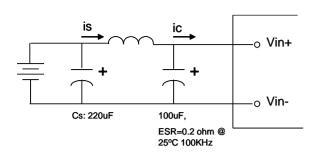


Figure 9: Test set-up diagram showing measurement points for Input Terminal Ripple Current and Input Reflected Ripple Current.

Note: Measured input reflected-ripple current with a simulated source Inductance (LTEST) of 12 µH. Capacitor Cs offset possible battery impedance. Measure current as shown above

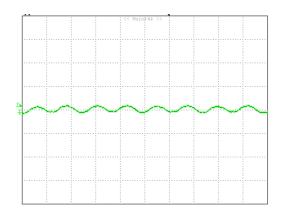


Figure 11: Input reflected ripple current, is, through a 12µH source inductor at nominal input voltage and rated load current (20 mA/div, 2us/div)

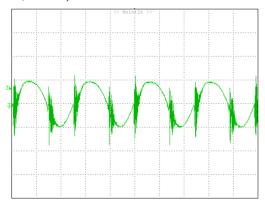


Figure 13: Output voltage ripple at nominal input voltage and rated load current (lo=7.5A)(50 mV/div, 1us/div)
Load capacitance: 1μF ceramic capacitor and 10μF tantalum capacitor. Bandwidth: 20 MHz. Scope measurements should be made using a BNC cable (length shorter than 20 inches).
Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module.

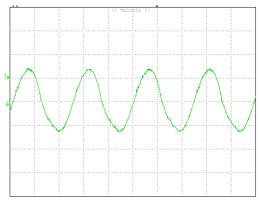


Figure 10: Input Terminal Ripple Current, ic, at full rated output current and nominal input voltage with 12µH source impedance and 33µF electrolytic capacitor (200 mA/div, 1us/div)

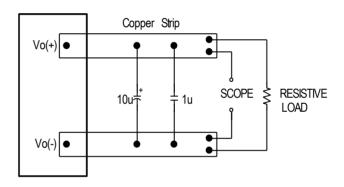


Figure 12: Output voltage noise and ripple measurement test setup

DESIGN CONSIDERATIONS

Input Source Impedance

The impedance of the input source connecting to the DC/DC power modules will interact with the modules and affect the stability. A low ac-impedance input source is recommended. If the source inductance is more than a few μH , we advise adding a 100 μF electrolytic capacitor (ESR < 0.7 Ω at 100 kHz) mounted close to the input of the module to improve the stability.

Layout and EMC Considerations

Delta's DC/DC power modules are designed to operate in a wide variety of systems and applications. For design assistance with EMC compliance and related PWB layout issues, please contact Delta's technical support team. An external input filter module is available for easier EMC compliance design. Below is the reference design for an input filter tested with V48SC120XXX to meet EN55032 (VDE0878) class A(both q. peak and average)

Schematic and Components List

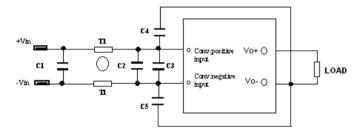


Figure 14 - EMI test schematic

C1= 3.3uF/100 V

C2= 47uF/100 V

C3= 47uF/100 V

C4=C5=1nF/250Volt

T1=1mH, type P53910(Pulse)

Test Result:

At $T = +25^{\circ}C$. Vin = 48 V and full load.

Yellow line is quasi peak mode; Blue line is average mode.

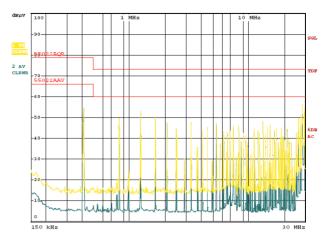


Figure 15 - EMI test negative line

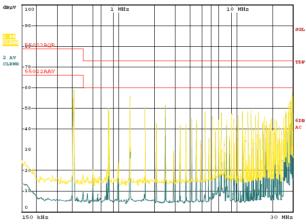


Figure 16 - EMI test positive line

Safety Considerations

The power module must be installed in compliance with the spacing and separation requirements of the end-user's safety agency standard, i.e. IEC 62368-1: 2014 (2nd edition), EN 62368-1: 2014 (2nd edition), UL 62368-1, 2nd Edition, 2014-12-01 and CSA C22.2 No. 62368-1-14, 2nd Edition, UL60950-1, CSA C22.2 NO. 60950-1 2nd and IEC 60950-1 2nd : 2005 and EN 60950-1 2nd: 2006+A11+A1: 2010, if the system in which the power module is to be used must meet safety agency requirements.

Basic insulation based on 75 Vdc input is provided between the input and output of the module for the purpose of applying insulation requirements when the input to this DC-to-DC converter is identified as TNV-2 or SELV. An additional evaluation is needed if the source is other than TNV-2 or SELV.

When the input source is SELV circuit, the power module meets SELV (safety extra-low voltage) requirements. If the input source is a hazardous voltage which is greater than 60 Vdc and less than or equal to 75 Vdc, for the module's output to meet SELV requirements, all of the following must be met:

- The input source must be insulated from the ac mains by reinforced or double insulation.
- The input terminals of the module are not operator accessible.
- A SELV reliability test is conducted on the system where the module is used, in combination with the module, to ensure that under a single fault, hazardous voltage does not appear at the module's output.

When installed into a Class II equipment (without grounding), spacing consideration should be given to the end-use installation, as the spacing between the module and mounting surface have not been evaluated.

The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

This power module is not internally fused. To achieve optimum safety and system protection, an input line fuse is highly recommended. The safety agencies require a Fast-acting fuse with 20A maximum rating to be installed in the ungrounded lead. A lower rated fuse can be used based on the maximum inrush transient energy and maximum input current.

Soldering and Cleaning Considerations

Post solder cleaning is usually the final board assembly process before the board or system undergoes electrical testing. Inadequate cleaning and/or drying may lower the reliability of a power module and severely affect the finished circuit board assembly test. Adequate cleaning and/or drying is especially important for un-encapsulated and/or open frame type power modules. For assistance on appropriate soldering and cleaning procedures, please contact Delta's technical support team.

Over-Current Protection

The modules include an internal output over-current protection circuit, which will endure current limiting for an unlimited duration during output overload. If the output current exceeds the OCP set point, the modules will automatically shut down, and enter hiccup mode or latch mode, which is optional, the default is hiccup mode.

For hiccup mode, the module will try to restart after shutdown. If the over current condition still exists, the module will shut down again. This restart trial will continue until the over-current condition is corrected.

Over-Voltage Protection

The modules include an internal output over-voltage protection circuit, which monitors the voltage on the output terminals. If this voltage exceeds the over-voltage set point, the module will shut down, and enter in hiccup mode or latch mode, which is optional, the default is hiccup mode.

For hiccup mode, the module will try to restart after shutdown. If the over voltage condition still exists, the module will shut down again. This restart trial will continue until the over-voltage condition is corrected.

For latch mode, the module will latch off once it shutdown. The latch is reset by either cycling the input power or by toggling the on/off signal for one second.

Over-Temperature Protection

The over-temperature protection consists of circuitry that provides protection from thermal damage. If the temperature exceeds the over-temperature threshold the module will shut down, and enter in auto-restart mode or latch mode, which is optional, the default is auto-restart mode.

For auto-restart mode, the module will monitor the module temperature after shutdown. Once the temperature is dropped and within the specification, the module will be auto-restart.

Remote On/Off

The remote on/off feature on the module can be either negative or positive logic. Negative logic turns the module on during a logic low and off during a logic high. Positive logic turns the modules on during a logic high and off during a logic low.

Remote on/off can be controlled by an external switch between the on/off terminal and the Vi(-) terminal. The switch can be an open collector or open drain.

For negative logic if the remote on/off feature is not used, please short the on/off pin to Vi(-). For positive logic if the remote on/off feature is not used, please leave the on/off pin floating.

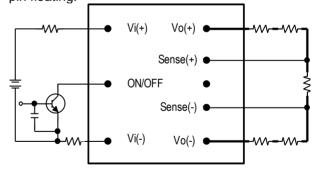


Figure 17: Remote on/off implementation

Remote Sense

Remote sense compensates for voltage drops on the output by sensing the actual output voltage at the point of load. The voltage between the remote sense pins and the output terminals must not exceed the output voltage sense range given here:

$$[Vo(+) - Vo(-)] - [SENSE(+) - SENSE(-)] \le 10\% \times Vout$$

This limit includes any increase in voltage due to remote sense compensation and output voltage set point adjustment (trim).

FEATURES DESCRIPTIONS (CON.)

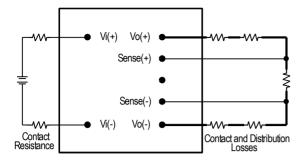


Figure 18: Effective circuit configuration for remote sense operation

If the remote sense feature is not used to regulate the output at the point of load, please connect SENSE(+) to Vo(+) and SENSE(-) to Vo(-) at the module.

The output voltage can be increased by both the remote sense and the trim; however, the maximum increase is the larger of either the remote sense or the trim, not the sum of both.

When using remote sense and trim, the output voltage of the module is usually increased, which increases the power output of the module with the same output current.

Max rated current is guaranteed at full output voltage remote sense range.

Output Voltage Adjustment (TRIM)

To increase or decrease the output voltage set point, connect an external resistor between the TRIM pin and SENSE(+) or SENSE(-). The TRIM pin should be left open if this feature is not used.

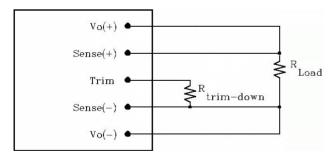


Figure 19: Circuit configuration for trim-down (decrease output voltage)

If the external resistor is connected between the TRIM and SENSE (-) pins, the output voltage set point decreases (Fig. 19). The external resistor value required to obtain a percentage of output voltage change \triangle % is defined as:

$$Rtrim - down = \left[\frac{511}{\Delta} - 10.22\right] (K\Omega)$$

Ex. When Trim-down -10% (12Vx0.9=10.8V)

$$Rtrim - down = \left[\frac{511}{10} - 10.22\right] (K\Omega) = 40.88(K\Omega)$$

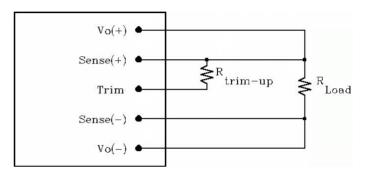


Figure 20: Circuit configuration for trim-up (increase output voltage)

If the external resistor is connected between the TRIM and SENSE (+) the output voltage set point increases (Fig. 20). The external resistor value required to obtain a percentage output voltage change \triangle % is defined as:

$$Rtrim - up = \frac{5.11 \text{Vo} (100 + \Delta)}{1.225 \Delta} - \frac{511}{\Delta} - 10.22 (K\Omega)$$

Ex. When Trim-up +10% (12Vx1.1=13.2V)

$$Rtrim - up = \frac{5.11 \times 12 \times (100 + 10)}{1.225 \times 10} - \frac{511}{10} - 10.22 = 489.31 (K\Omega)$$

Trim resistor can also be connected to Vo+ or Vo- but it would introduce a small error voltage than the desired value.

The output voltage can be increased by both the remote sense and the trim, however the maximum increase is the larger of either the remote sense or the trim, not the sum of both.

THERMAL CONSIDERATIONS

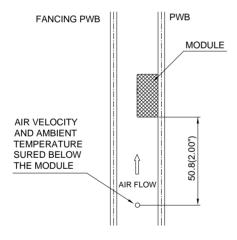
Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Convection cooling is usually the dominant mode of heat transfer.

Hence, the choice of equipment to characterize the thermal performance of the power module is a wind tunnel.

Thermal Testing Setup

Delta's DC/DC power modules are characterized in heated vertical wind tunnels that simulate the thermal environments encountered in most electronics equipment. This type of equipment commonly uses vertically mounted circuit cards in cabinet racks in which the power modules are mounted.

The following figure shows the wind tunnel characterization setup. The power module is mounted on a test PWB and is vertically positioned within the wind tunnel. The space between the neighboring PWB and the top of the power module is constantly kept at 6.35mm (0.25").



Note: Wind Tunnel Test Setup Figure Dimensions are in millimeters and (Inches)

Figure 21: Wind tunnel test setup

Thermal Derating

Heat can be removed by increasing airflow over the module. To enhance system reliability, the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum module temperature, reliability of the unit may be affected.

THERMAL CURVES (OPEN FRAME)

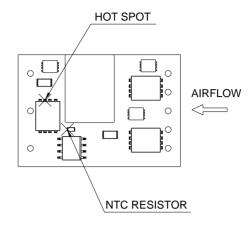


Figure 22: * Hot spot 1& NTC resistor temperature measurement location. The allowed maximum hot spot temperature is defined at 120 $^{\circ}$

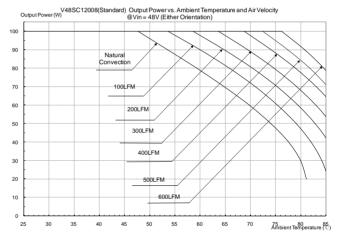
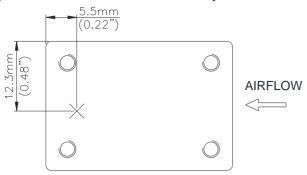


Figure 23: Output Power vs. Ambient Temperature and Air Velocity @ Vin=48V (Either Orientation, Open Frame)

THERMAL CURVES (WITH HEAT SPREADER)



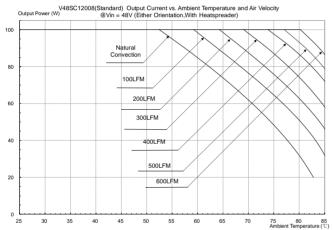
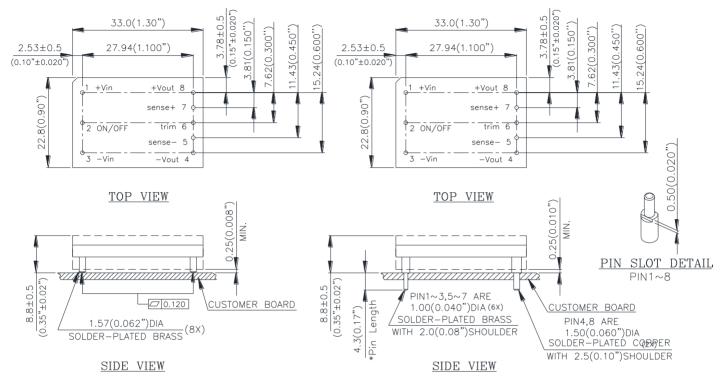


Figure 25: Output Power vs. Ambient Temperature and Air Velocity @ Vin=48V (Either Orientation, with heat spreader)

MECHANICAL DRAWING

Surface-mount module

Through-hole module



*Standard pin tail length. Optional pin tail lengths shown in PART NUMBERING SYSTEM

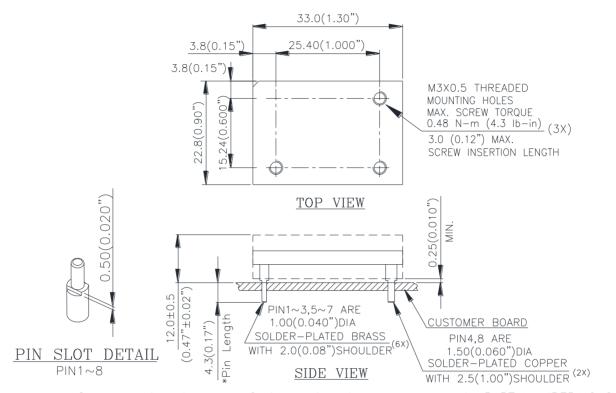
NOTES:
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)

Note: All pins are copper alloy with matte Tin (Pb free) plated over Nickel under plating.

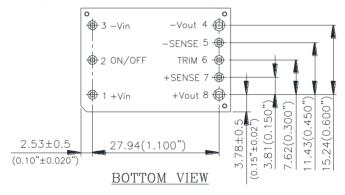
MECHANICAL DRAWING

Through-hole module with heat spreader

For modules with through-hole pins and the optional heat-spreader, they are intended for wave soldering assembly onto system boards; please do not subject such modules through reflow temperature profile.



*Standard pin tail length. Optional pin tail lengths shown in PART NUMBERING SYSTEM



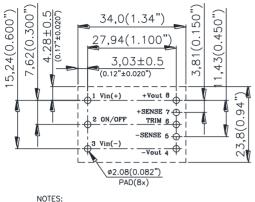
NOTES:

DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)

Note: All pins are copper alloy with matte Tin (Pb free) plated over Nickel under plating.

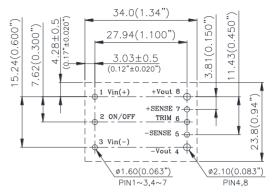
SUGGESTED PCB LAYOUT

Surface-mount pin module



NOTES:
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)

Through hole module

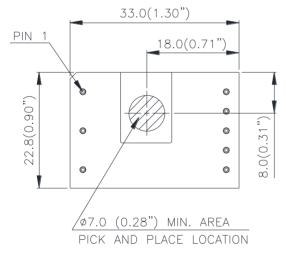


NOTES:
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)

Note: Customer can base on the actual solder performance to adjust the hole and pad size.

SURFACE MOUNT MODEL PACKING INFORMATION

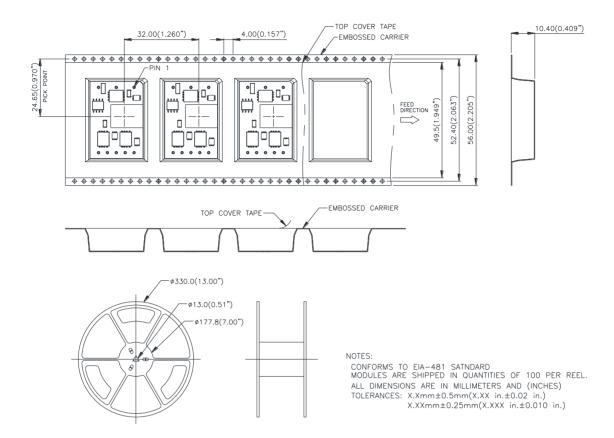
Pick and place location/size (surface mount only)



NOTES:

ALL DIMENSIONS ARE IN MILLIMETERS AND (INCHES) TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.) X.XXmm±0.25mm(X.XXX in.±0.010 in.)

Packing information (surface mount only)



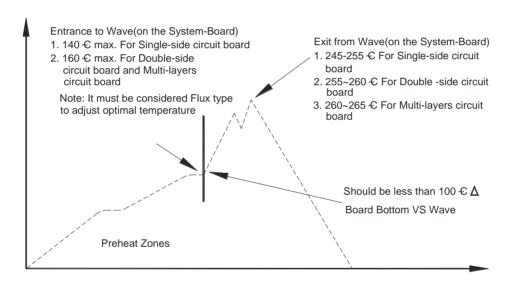
SOLDERING METHOD

Generally, as the most common mass soldering method for the solder attachment, wave soldering is used for through-hole power modules and reflow soldering is used for surface-mount ones. Delta recommended soldering methods and process parameters are provided in this document for solder attachment of power modules onto system board. SAC305 is the suggested lead-free solder alloy for all soldering methods. The soldering temperature profile presented in this document is based on SAC305 solder alloy.

Reflow soldering is not a suggested method for through-hole power modules due to many process and reliability concerns. If you have this kind of application requirement, please contact Delta sales or FAE for further confirmation.

Wave Soldering (Lead-free)

Delta's power modules are designed to be compatible with single-wave or dual wave soldering. The suggested soldering process must keep the power module's internal temperature below the critical temperature of 217°C continuously. The recommended wave-soldering profile is shown below:

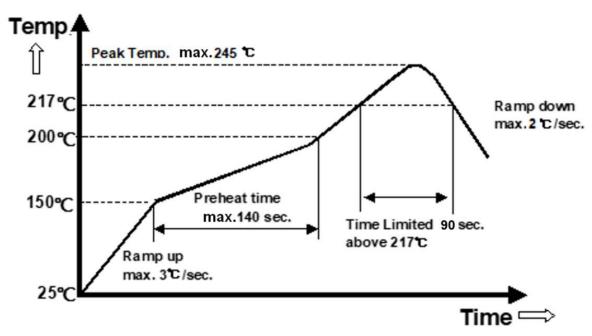


Note: The temperature is measured on solder joint of pins of power module.

The typical recommended (for double-side circuit board) preheat temperature is $115+/-10^{\circ}C$ on the top side (component side) of the circuit board. The circuit-board bottom-side preheat temperature is typically recommended to be greater than $135^{\circ}C$ and preferably within $100^{\circ}C$ of the solder-wave temperature. A maximum recommended preheat up rate is $3^{\circ}C$ /s. A maximum recommended solder pot temperature is $255+/-5^{\circ}C$ with solder-wave dwell time of $3\sim6$ seconds. The cooling down rate is typically recommended to be $6^{\circ}C/s$ maximum.

Reflow Soldering (Lead-free)

High temperature and long soldering time will result in IMC layer increasing in thickness and thereby shorten the solder joint lifetime. Therefore the peak temperature over 245°C is not suggested due to the potential reliability risk of components under continuous high-temperature. In the meanwhile, the soldering time of temperature above 217°C should be less than 90 seconds. Please refer to following fig for recommended temperature profile parameters.



Note: The temperature is measured on solder joint of pins of power module

Hand Soldering (Lead Free)

Hand soldering is the least preferred method because the amount of solder applied, the time the soldering iron is held on the joint, the temperature of the iron, and the temperature of the solder joint are variable. The recommended hand soldering guideline is listed in Table below. The suggested soldering process must keep the power module's internal temperature below the critical temperature of 217°C continuously.

Parameter	Single-side	Double-side	Multi-layers
Parameter	Circuit Board	Circuit Board	Circuit Board
Soldering Iron Wattage	90	90	90
Tip Temperature	385+/-10℃	420+/-10℃	420+/-10℃
Soldering Time	$2 \sim 6$ seconds	$4 \sim 10$ seconds	$4 \sim 10$ seconds

PART NUMBERING SYSTEM

V	48	S	С	120	08	N	R	F	Α
Type of Product	Input Voltage	Number of Outputs	Product Series	Output Voltage	Output Current	ON/OFF Logic	Pin Length/Type		Option Code
V - 1/16 Brick	48 - 36V~75V	S - Single	C - Serial number	120 - 12V	08 - 8.3A	N - Negative P - Positive	N - 0.145"	1 - 10113 0/0	A - Standard Functions H - With heat spreader

RECOMMENDED PART NUMBER

MODEL NAME	INPUT		OUT	PUT	EFF @ 100% LOAD	
V48SC12008NRFA	36~75V	3.1A	12V	8.3A	92%	
V48SC12008NRFH	36~75V	3.1A	12V	8.3A	92%	

Default remote on/off logic is negative and pin length is 0.170"

For different remote on/off logic and pin length, please refer to part numbering system above or contact your local sales office.

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WARRANTY

Delta offers a two (2) year limited warranty. Complete warranty information is listed on our web site or is available upon request from Delta.

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